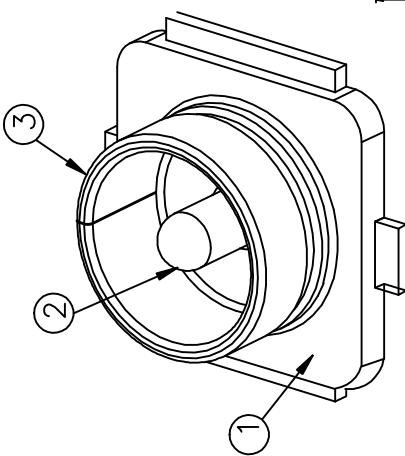
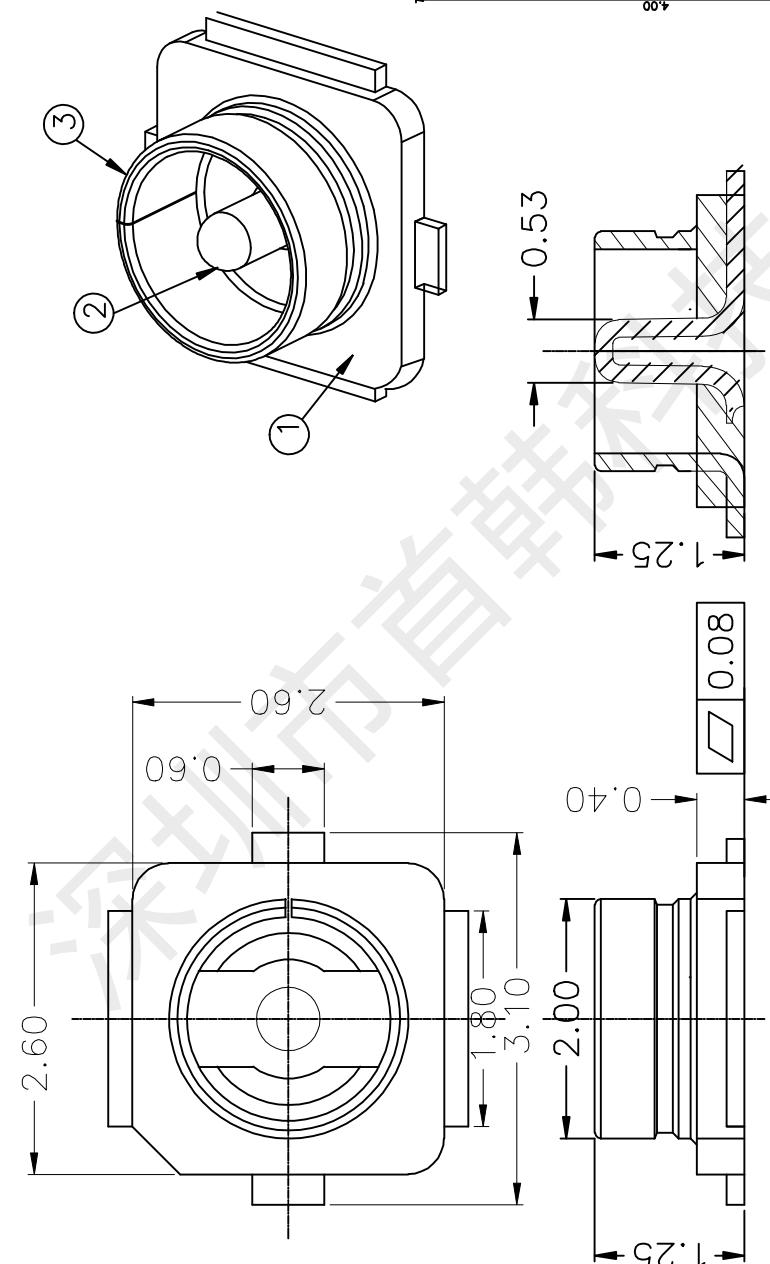


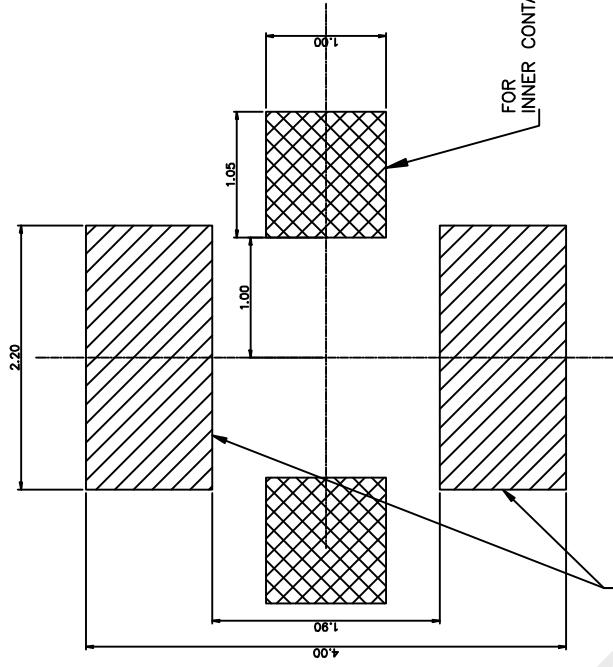
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REV.	ECN NO.	DESIGNER	DATE
A			

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NOTE: 1  
 1. ELECTRICAL CHARACTERISTICS:  
 1.1 CURRENT RATING: 0.5A MAX.  
 1.2 IMPEDANCE: 50ΩH NOMINAL.  
 2. MECHANICAL CHARACTERISTICS:  
 2.1 OPERATING TEMP. -40°~90°  
 2.2 VENR UP TO 3GHz: 1.3MAX.  
 3GHz TO 6GHz: 1.4MAX.  
 2.3 DURABILITY: 30CYCLES



## NOTE: 2

1. HOUSING MATERIAL: LCP, NATURE, UL94V-0.

2. TERMINAL MATERIAL: COPPER ALLOY (C2680),

Au:1u" (CFP120W11)

Au:3u" (CFP123W11)

Au:5u" (CFP125W11),

Ni:50~120u".

Ni:50~120u".

Au:1u" (CFP120W11)

Au:3u" (CFP123W11)

Au:5u" (CFP125W11),

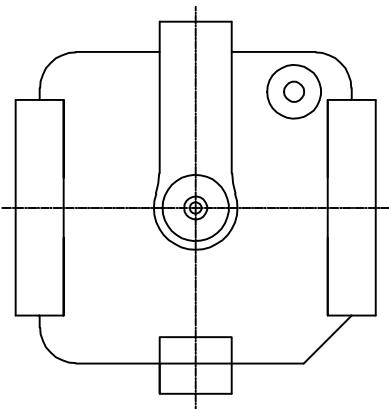
Ni:50~120u".

Au:1u" (CFP120W11)

Au:3u" (CFP123W11)

Au:5u" (CFP125W11),

Ni:50~120u".



3. SHELL MATERIAL: COPPER ALLOY (C5191),

Au:1u" (CFP120W11)

Au:3u" (CFP123W11)

Au:5u" (CFP125W11),

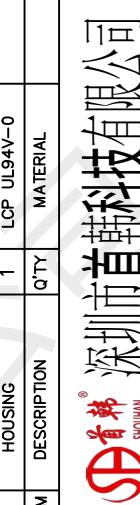
Ni:50~120u".

Au:1u" (CFP120W11)

Au:3u" (CFP123W11)

Au:5u" (CFP125W11),

Ni:50~120u".



IPLEX1-4-TXZ 214

DWG NO.: 113-0000-004

PART NO.: CFP120W11

1/1 A

ITEM	DESCRIPTION	Q'TY	MATERIAL	FINISH	REMARK
3	GROUND CONTACT	1	COPPER ALLOY	AU PLATING OVER NI OVER ALL	
2	INNER CONTACT	1	COPPER ALLOY	AU PLATING OVER NI OVER ALL	
1	HOUSING	1	LCP UL94V-0		

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深圳市首韩科技有限公司

SHENZHEN SHOUHAN TECHNOLOGY CO., LTD

Tel: 0755-27597601 Fax: 0755-27597491

## 承 认 书

## SPECIFICATION FOR APPROVAL

客 户 Customer:

---

产品名称 Project:

天线座

---

规格型号 Part No:

IPEX1-4-TXZ 214

### 贵公司承认印 Approal Signatures

料 号/Part No.	签 章/Signatures

日期 Date:

拟制/Drawn	李春风	
审核/Check	钟华华	
批准/Approved	罗孝金	



## 1. 规格要求 Requirements:

### 1.1 应用条件 Application Condition:

#### 1.1.1 使用环境 Operating Environment:

温度: -40°C to +90°C, 相对湿度: 25%~85%, 此条件下功能不可失效。

Temperature: -40°C to +90°C, Relative Humidity: 25%~85%, Without loss of function.

#### 1.1.2 储存环境 Storage Environment:

温度: -55°C to +100°C, 相对湿度: 95% 或更低, 此条件下功能不可失效。

Temperature: -55°C to +100°C, Relative Humidity: 95% or Less, Without loss of function.

#### 1.1.3 额定值 Ratings:

A. 额定电压 Voltage Rating: 60VAC

B. 公称特性 Nominal characteristic impedance: 50Ω

C. 周波数 Frequency: DC0.1~6GHz

D. VSWR: Plug 1.3Max.(DC0.1~3GHz), 1.5Max.(3~6GHz)

Receptacle 1.3Max.(DC0.1~3GHz), 1.4Max.(3~6GHz)

### 1.2 绿色环保要求 Health, Safety and Environment

此产品中所有涉及环保有关的有害物质管控标准请参考 SGS

Hazardous substances (Environment related to be controlled substances) contained in this product should comply with the regulations specified by SGS

### 1.3 测试说明 Test Description

此产品性能须满足本文件 3.4 节中的各项规格要求。除非有特别申明, 所有的测试和量测必须在以下条件下进行:

The product is designed to meet the requirements specified in section 3.4. Unless otherwise specified, all tests and measurements are to be performed under the following conditions:

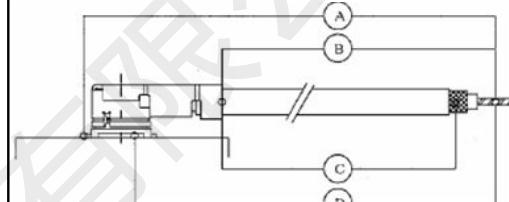
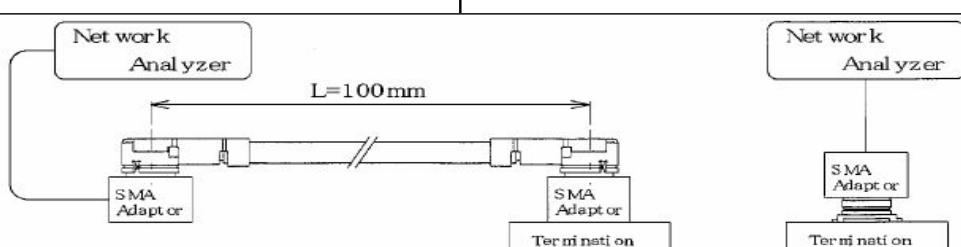
温度 Temperature: 15~35°C

相对湿度 Humidity: 45% ~ 75%

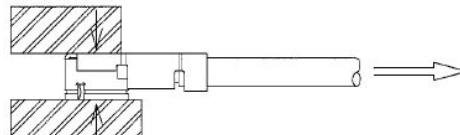


## 1.4 测试规范和方法 Test Requirements and Methods

**Table I: 性能要求 Performance Requirements**

项目 Items	规格要求 Requirements	测试方法 Test Methods
1.4.1 产品外观  Visual Examination	所有零件必须组装完好, 不能出现毛边, 变形, 刮伤, 以及任何外观破坏等异常;  All components shall be properly assembled and free of burrs, warps, scratches, broken chips, and other abnormalities	参考测试标准: EIA 364-18B 依照相应的文件和规格书进行外观, 功能, 及尺寸的检验量测.  Comply with method EIA 364-18B Visual, functional, and dimensional inspection complies with applicable specification and document.
1.4.2 低功率接触阻抗  Low Level Contact Resistance	初值最大 20mΩ  20mΩ Max Initial  终值最大 70mΩ  70mΩ Max. Final.	  Inner contact=A-B Ground contact=D-C
1.4.3 绝缘阻抗  Insulation Resistance	初期最小 500 MΩ  500 MΩ Min Initial  终期最小 100 MΩ  100 MΩ Min Final	参考测试标准: EIA-364-21D. 在相邻两支端子之间加 100V 直流电压并保持 1 分种, 测出阻抗值.  Comply with method EIA-364-21D. Insulation resistance is measured between adjacent contacts after applying 100V DC for 1 minutes.
1.4.4 耐电压  Dielectric Withstanding Voltage	加电压期间漏电流不超过 0.5mA. 同时不能产生电弧以及而产生的短路和破坏产品的绝缘性能.  No evidence of breakdown or flash burn. No burn caused by short circuit. No insulation destruction. Current leakage: 0.50 mA Max.	参考测试标准: EIA-364-20D, 方法 B; 在产品以及与之配对的 plug 之间加 300V 交流电压保持 1 分种, 监控漏电流.  Comply with method EIA-364-20D, Test Method B. apply 300V AC 1 minute at sea level on tested plug and connectors.
1.4.5 电压驻波比  VSWR	Plug 1.3 以下 0.1~3GHz, 1.5 以下 3~6GHz Plug 1.3Max.at 0.1~3GHz, 1.5 Max.at 3~6GHz Receptacle 1.3 以下 0.1 ~3GHz, 1.4 以下 3~6GHz Receptacle 1.3Max.at 0.1~3GHz, 1.4Max.at 3~6GHz.	周波数:100M~6GHz  Measure the VSWR as shown by the network analyzer. Frequency:100M~6GHz  



项目 Items	规格要求 Requirements	测试方法 Test Methods
1.4.6 拔去力 Un-mating force	综合拔去力:初回拔去力 5 N 以上, 30回后拔去力 3N 以上  Total un-mate force: Initial 5N Min. after 30 cycles 3N Min	插拔试验机以每分 $25\pm3$ mm 的速度 进行插拔  Un-mate the receptacle connector(soldered to the test board)and plug at a speed $25\pm3$ mm/minutes along the mating by the push-on/pull-off machine
1.4.7 引张强度 Crimp strength	5N 以上 5N MIN	通过引张试验机以每分 $25\pm3$ 毫米/ 分钟的速度拉线材部分.  Pull the cable as shown at a speed $25\pm3$ mm/minutes by tensile strength machine.  
1.4.8 耐插拔 Durability	中心导体接触阻抗: 初期 $20 \text{ m}\Omega$ , 以 下, 试验后 $40 \text{ m}\Omega$ 以下  Contact resistance of inner contact initial 20 milli-ohm  MAX. after testing $40\text{milli-ohm MAX.}$  外部导体接触阻抗: 初期 $20 \text{ m}\Omega$ , 以下, 试验后 $40 \text{ m}\Omega$ 以下  Contact resistance of ground contact initial 20 mille-ohm  MAX.after testing $40\text{milli-ohm MAX.}$  外观无损伤  No abnormality	母头连接器焊接在板上以每分钟 $25\pm3$ mm 的速度插拔 30 次  Mate and un-mate the receptacle connector (soldered to the test board)and plug 30 cycles at a speed $25\pm3$ mm/minutes along the mating by the push-on/pull-off machine.  参考测试标准: EIA-364-09C;
1.4.9	部品无外观及其它异常.	施加力于图 Fig.1 方向



	<p>线材保持力 Cable retention force</p> <p>Appearance: Looseness between the parts, chipping, breakage or other abnormality shall not occur</p> <p>试验中无 1 微秒的电流中断 Electrical discontinuity :No electrical discontinuity grater than 1 micro-sec.shall occur.</p> <p>中心导体接触阻抗: 初期 20 mΩ, 以下, 试验后 40 mΩ以下 Contact resistance of inner contact initial 20 milli-ohm MAX. after testing 40milli-ohm MAX.</p> <p>外部导体接触阻抗: 初期 20 mΩ, 以下, 试验后 40 mΩ以下 Contact resistance of ground contact initial 20 milli-ohm MAX. after testing 40milli-ohm MAX.</p>	<p>Apply force on the cable as shown</p> <p>试验期间工作电流 100mA DC, 检查瞬间电流中断. During the testing, run 100mA DC to check electrical discontinuity.</p>
1.4.10 振动 Vibration	<p>外观无异常 Apply the following vibration to the mating connector.</p> <p>试验中不得有超过 1 微秒的漏电流产生 Electrical discontinuity: No electrical discontinuity grater than 1micro-sec.shall occur.</p> <p>中心导体接触阻抗: 初期 20 mΩ, 以下, 试验后 40mΩ以下 Contact resistance of inner contact initial 20 milli-ohm MAX. after testing 40milli-ohm MAX.</p>	<p>嵌合状态下振动, 试验中电流瞬断的确认. Apply the following vibration to the mating connector.</p> <p>周波数:10Hz-100Hz-10Hz 约 20 分 Frequency:10Hz-100Hz-10Hz/approx 20 minutes.</p> <p>片振幅, 加速度: 1.5mm or 59m/s<sup>2</sup>(6G) Half amplitude, peak value of acceleration:1.5mm or 59m/s<sup>2</sup>(6G)</p> <p>方向:三个互相垂直的方向 3 次实施. Directions,cycle:3 mutually</p>



	外部导体接触阻抗：初期 20 mΩ，以下，试验后 40 mΩ以下 Contact resistance of ground contact initial 20 milli-ohm MAX. after testing 40milli-ohm MAX.	perpendicular direction,3 cycles for each direction. 测试期间连接 100mA DC During the testing run 100mA DC 参考测试标准：EIA-364-28E,
1.4.11 物理冲击 Physical shock	外观无异常 Appearanec:Looseness between the parts,chipping,breakage or other abnormality shall not occur. 不得有超过 1 微秒的漏电流产生。 Electrical discontinuity: No electrical discontinuity grater than 1 micro-sec.shall occur. 中心导体接触阻抗:初期 20 mΩ以下,试验后 40 mΩ以下。 Contact resistance of inner contact initial 20 milli-ohm MAX. after testing 40milli-ohm MAX. 外部导体接触阻抗:初期 20 mΩ以下,试验后 40 mΩ以下。 Contact resistance of ground contact initial 20 milli-ohm MAX. after testing 40milli-ohm MAX.	嵌合状态在冲击试验机下冲击,试验中 DC100mA 电流的瞬断确认。参考标准 EIA-364-27B. Apply the following vibration to the mating connector in accordance with MIL-STD-202,Method213,Condition B.During the testing, run 100mA DC to check electrical 最大加速度:735m/s <sup>2</sup> (75G) Peak value of acceleration:735m/s <sup>2</sup> (75G). Duration:11msec Wave Form: half sinusoidal Diretions,cycle:6 mutually perpendicular,3 cycles about each direction. 参考测试标准：EIA-364-27B.
1.4.12 耐湿性 Humidity	部品无外观及其它异常 Appearance: Looseness between the parts, chipping, breakage or other abnormality shall not occur. 中心导体接触阻抗：初期 20 mΩ, 以下，试验后 40 mΩ以下 Contact resistance of inner contact initial 20 milli-ohm MAX.after testing	嵌合状态的连接器在以下环境放置. Apply the following environment to the mating connector in accordance with 温度:313+/-2K(40+/-2°) Temperature:313+/-2K(40+/-2°) 湿度:90~95%RH Humidity:90~95%RH 时间:96 小时

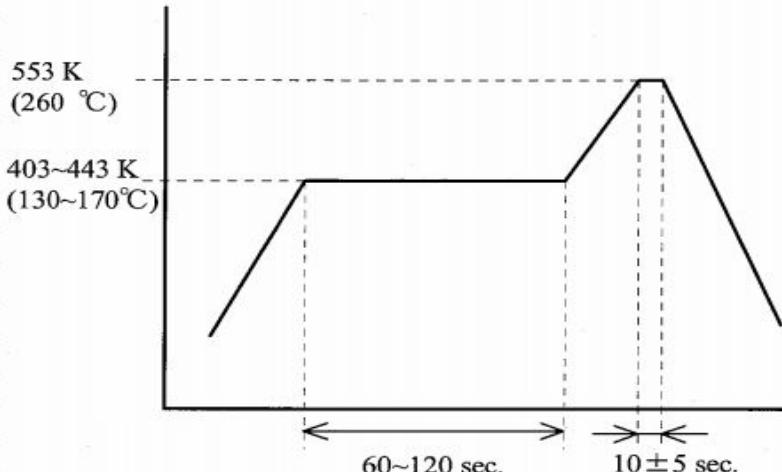


	<p>40milli-ohm MAX.</p> <p>外部导体接触阻抗：初期 20 mΩ, 以下，试验后 40 mΩ以下</p> <p>Contact resistance of ground</p> <p>contact initial 20 mille-ohm</p> <p>MAX.after testing</p> <p>40milli-ohm MAX</p> <p>绝缘阻抗:初期 500MΩ 以上, 试验后 100MΩ以上.</p> <p>Insulation resistance: initial 500 mega-ohm MIN.after testing 100 mega-ohm MIN.</p> <p>耐电压:沿面放电,空中放电,绝缘破坏无异常发生.</p> <p>D.W.Voltage:No creeping discharge,flashover,nor insulator breakdown shall occur</p>	<p>Duration:96 hours</p> <p>参考测试标准: EIA-364-31C 中方法 II,条件 A;</p>
1.4.13 热冲击 Thermal shock	<p>部品无外观及其它异常</p> <p>Appearance: Looseness between the parts, chipping, breakage or other abnormality shall not occur.</p> <p>中心导体接触阻抗：初期 20 mΩ, 以下，试验后 40 mΩ以下</p> <p>Contact resistance of inner</p> <p>contact initial 20 milli-ohm</p> <p>MAX.after testing</p> <p>40milli-ohm MAX.</p> <p>外部导体接触阻抗：初期 20 mΩ, 以下，试验后 40 mΩ以下</p> <p>Contact resistance of ground</p> <p>contact initial 20 mille-ohm</p> <p>MAX. after testing 40milli-ohm MAX</p> <p>绝缘阻抗:初期 500MΩ 以上, 试验后</p>	<p>嵌合状态的连接器在以下环境</p> <p>Apply the following environment to the mating connector.</p> <p>温度 Temperature:</p> <p>218K(-55°C) :30 min. ↔ 358K(85°C): min.</p> <p>移动时间 Transition time:</p> <p>5 min. Max.</p> <p>回数 No.of cycles:</p> <p>5 cycles</p> <p>参考测试标准: EIA-364-32E;</p>



	<p>100MΩ以上.</p> <p>Insulation resistance: initial 500 mega-ohm MIN.after testing 100 mega-ohm MIN.</p> <p>耐电压:沿面放电,空中放电,绝缘破坏无异常发生.</p> <p>D.W.Voltage:No creeping discharge,flashover,nor insulator breakdown shall occur</p>	
1.4.14 高温寿命 Temperature Life	<p>部品无外观及其它异常</p> <p>Appearance: Looseness between the parts, chipping breakage or other abnormality shall not occur</p> <p>中心导体接触阻抗: 初期 20 mΩ, 以下, 试验后 40 mΩ以下</p> <p>Contact resistance of inner contact initial 20 milli-ohm MAX.after testing</p> <p>40milli-ohm MAX</p> <p>外部导体接触阻抗:初期 20 mΩ以下, 试验后 40 mΩ以下..</p> <p>Contact resistance of ground contact initial 20 mille-ohm MAX.after testing</p> <p>40milli-ohm MAX</p>	<p>嵌合状态的连接器放置以下环境</p> <p>Apply the following environment to the mating connector in accordance</p> <p>温度 363+/-2K(90+/-2°)</p> <p>Temperature:363+/-2K(90+/-2°)</p> <p>时间:96 小时</p> <p>Duration:96 hours</p> <p>参考测试标准: EIA-364-17B;</p>
1.4.15 硫化氢测试 H2S Gas	<p>外观无异常,性能良好</p> <p>Appearance no abnormality adversely affecting the performance shall occur</p> <p>中心导体接触阻抗: 初期 20 mΩ, 以下, 试验后 40 mΩ以下.</p> <p>Contact resistance of inner contact initial 20 milli-ohm MAX.after testing 40milli-ohm MAX.</p> <p>外部导体接触阻抗:初期 20 mΩ以下, 试验后 40 mΩ以下.</p> <p>Contact resistance of ground contact initial 20 mille-ohm MAX.after testing40milli-ohm MAX</p>	<p>嵌合状连接器放置于以下条件下:</p> <p>Apply the following environment to the mating connector in accordance</p> <p>温度: 313+/-2K(40+/-2°)</p> <p>Temperature:313+/-2K(40+/-2°)</p> <p>湿度: 80+/-5%RH</p> <p>Relative Humidity: 80+/-5%RH</p> <p>气体:H2S 3+/-1ppmGas:H2S 3+/-1ppm</p> <p>时间:96 小时Duration:96 hours</p>



1.4.16 盐雾腐蚀 Salt spray	外观无异常,性能良好 Appearance no abnormality adversely affecting the performance shall occur 中心导体接触阻抗: 初期 20 mΩ,以下, 试验后 40 mΩ以下. Contact resistance of inner contact initial 20 milli-ohm MAX.after testing 40milli-ohm MAX. 外部导体接触阻抗:初期 20 mΩ以下, 试验后 40 mΩ以下. Contact resistance of ground contact initial 20 mille-ohm MAX.after testing 40milli-ohm MAX	嵌合状连接器放置于以下条件下: Apply the following environment to the mating connector in accordance with MIL-STD-202,Method 101 Condition B 温度: 308+/-2K(35+/-2°) Temperature:308+/-2K(35+/-2°) 盐水浓度:5+/-1%(重量比) Salt water density by weight:5+/-1% 时间:48 小时 Duration:48 hours 参考测试标准: EIA-364-26B 中方法 101,条件 B;
1.4.17 可焊性 Solder ability	焊锡表面浸渍超过 95%. More than 95%of the dipped surface shall be wet with solder.	将端子沉入 245°C +/-5°C 的焊液中 10+/-0.5 秒. Immerse the solder pin of the connector in the solder bath at 245°C +/-5°C for 5+/-0.5 seconds
1.4.18 耐焊接热 Soldering Heat Resistance	Appearance shall not be distinct damage.More than 95% of the mountin pin surface shall be wet solder	(1) Reflow part : 533 ± 5K (260 ± 5 °C) Peak 503K MIN. (230°C MIN.) 40~50sec. (2) Pre-heat part: 403~473K(130~200°C) 60~120sec. *Refer to reflow temperature profile. *The number of reflow is within 2 times.
		

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[R124076320](#)